

Product End of Life Disassembly Instructions

- 1. Product Category: Thin Client
- 2. Marking Name / Model: UltrArmor UA2 / N260
- **3.** System No.: 10D3H30xxx
- 4. PURPOSE:

This document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of UltrArmor UA2 products to remove components and materials requiring selective treatment, as defined by EU WEEE Directive 2012/19/EU

5. Selective Treatment for Material and Components according to ANNEX VII of DIRECTIVE 2012/19/EU on waste electrical and electronic equipment (WEEE)

Item Description	Notes	Q'ty of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)	With a surface greater than 10 sq cm	 In UA2: Main Board x1^{*1} memory modules x1^{*2} In power adapter x1^{*3}
Batteries	All types including standard alkaline and lithium coin or button style batteries	Lithium Coin Battery x1 ^{*4}
Mercury-Containing Components	For example, mercury in lamps, display backlights, scanner lamps, switches, batteries	
Liquid Crystal Displays(KCD) with a surface greater than 100 sq cm	Includes background illuminated displays with gas discharge lamps	
Cathode Ray Tubes (CRT)		
Capacitors / condensers (Containing PCB/PCT)		
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height		Not used in UA2 N260. in power adapter x1 ^{*5}
External Electrical Cables and cords		Power Cord for power adapter ^{*6}
Gas Discharge Lamps		
Plastics Containing Brominated Flame Retardants		
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner	Include the cartridges, print heads, tubes, vent chambers, and service stations	
Components and waste containing asbestos		
Components, parts and materials containing refractory ceramic fibers		
Components, parts and materials containing radioactive substances		

*1: See 7-6: Remove Main Board in page 5

*2: See 7-3: Remove mSATA SSD, RTC Battery, SO-DIMM Memory Modules in Page 4

*3: See 8-5. Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height in page 8

*4: See 7-3. Remove mSATA SSD, RTC Battery, SO-DIMM Memory Modules in page 4

*5: See 8-5. Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height in page 8

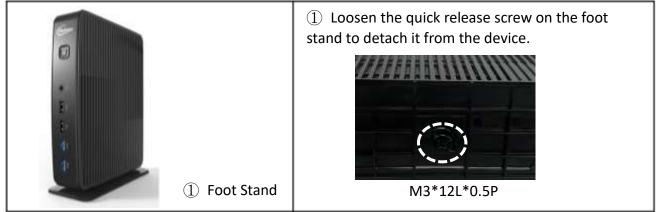
*6: See 8-2. External Electrical Cables and cords in page 7

6. Type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed



7. Disassembly Process.

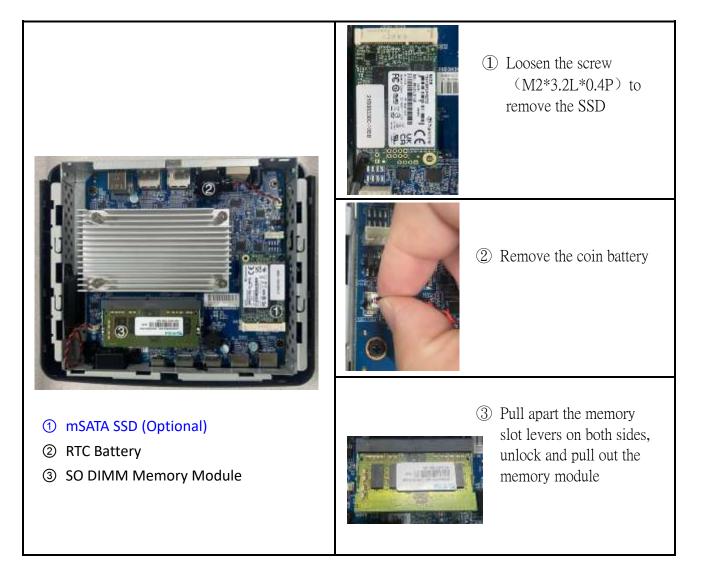
7-1. Remove Foot Stand



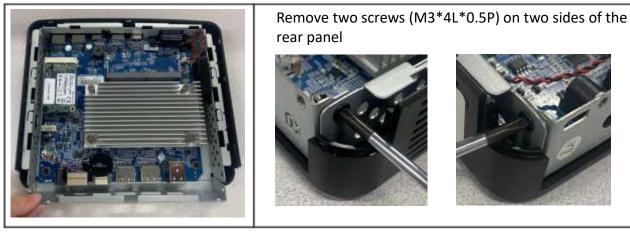
7-2. Remove Top Cover



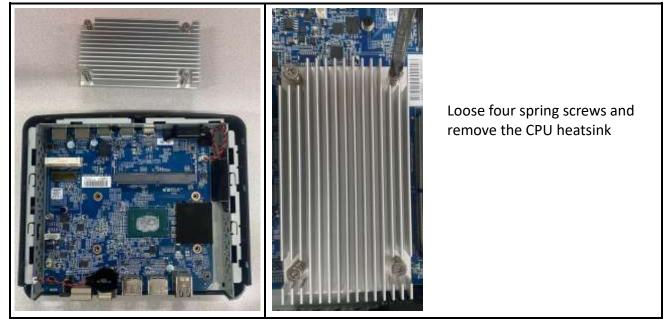
7-3. Remove mSATA SSD, RTC Battery, SO-DIMM Memory Modules



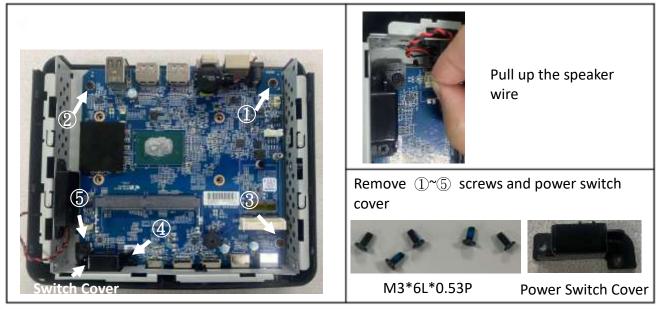
7-4. Remove Rear I/O Panel



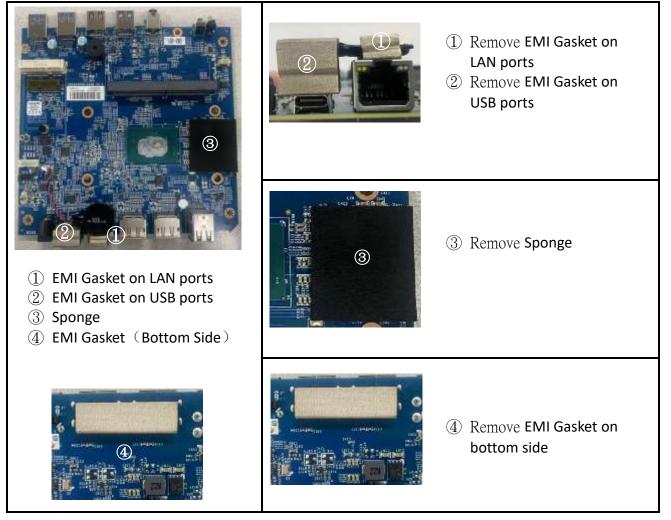
7-5. Remove CPU Heatsink



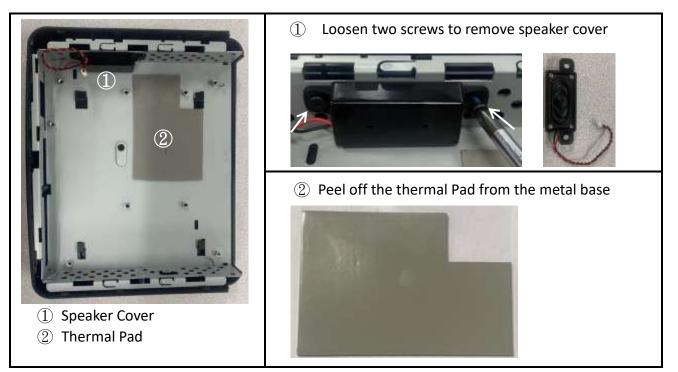
7-6. Remove Main Board



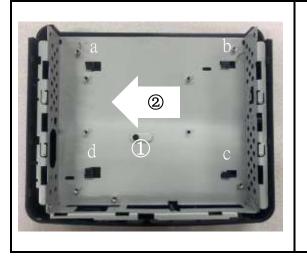
7-7. Remove on-board EMI parts & CPU Bracket



7-8. De-assemble Bottom Cover Assembly Parts



7-9. Disassemble Base Assembly Parts



- ① Loosen and remove this screw (M3*4L*1P)
- ② Push inner metal base in the direction of arrow and ensure that the four-point plastic hooks (a,b,c,d) are disengaged from the fixed state to remove the metal piece

8. Disposal

After you have disassembled the device completely, carefully dispose of the individual parts.

8-1. Representative plastics reference list (over 25g)



Bottom Base (116g)



Top Cover (68g)



Foot Stand (31g)

8-2. External Electrical Cables and cords



8-3. Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)



System Main Board



SO DIMM Memory



mSATA SSD (Optional)



Power Adaptor

8-4. Battery



Lithium Coin Battery

8-5. Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height

Notice 1: No such part designed in UA2 N260 product but it can be found in power adaptor. **Notice 2**: These instructions are intended solely for recycling organizations for disposal purposes only! After opening the power supply unit, it must no longer be used.

Step 1: Disassemble plastic housing

Use hammers, screw driver to break the plastic housing at the sealed joint





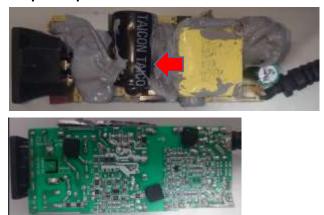
Step 2: Disassemble the metal & plastic parts around PCBA Module



Release the screws on brackets and PCB heatsink on the back to take them off and isolated mylar, too.



Step 3: Capacitor is accessible to be removed



Release two pins on the capacitor with pliers then remove the capacitor.

